# Vishay Siliconix



Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V, } I_{D} = -250 \mu\text{A}$	- 20			V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = - 250 μA		- 19		mV/°C
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$			2.6		
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	- 0.6		- 1.5	V
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 12 \text{ V}$			± 100	nA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = - 20 V, V <sub>GS</sub> = 0 V			- 1	μΑ
		V <sub>DS</sub> = - 20 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C			- 10	
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \le -5 \text{ V}, V_{GS} = -4.5 \text{ V}$	- 20			Α
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 3.6 A		0.048	0.058	Ω
		V <sub>GS</sub> = - 2.5 V, I <sub>D</sub> = - 1 A		0.081	0.100	
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = - 10 V, I <sub>D</sub> = - 3.6 A		10		S
Dynamic <sup>b</sup>	- 19			1	L	1
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> = - 10 V, V <sub>GS</sub> = 0 V, f = 1 MHz		480		pF
Output Capacitance	C <sub>oss</sub>			125		
Reverse Transfer Capacitance	C <sub>rss</sub>	30 40		90		
Total Gate Charge	Q <sub>g</sub>	V <sub>DS</sub> = - 10 V, V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 5 A		11	17	nC
		V <sub>DS</sub> = - 10 V, V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 5 A		5.5	8.5	
Gate-Source Charge	Q <sub>gs</sub>			1.2		
Gate-Drain Charge	Q <sub>gd</sub>			1.8		
Gate Resistance	R <sub>g</sub>	f = 1 MHz		9		Ω
Turn-On Delay Time	t <sub>d(on)</sub>	$V_{DD}$ = - 10 V, $R_L$ = 2.5 $\Omega$ $I_D \cong$ - 4 A, $V_{GEN}$ = - 4.5 V, $R_g$ = 1 $\Omega$		11	20	ns
Rise Time	t <sub>r</sub>			42	65	
Turn-Off Delay Time	t <sub>d(off)</sub>			33	50	
Fall Time	t <sub>f</sub>			50	75	
Turn-On Delay Time	t <sub>d(on)</sub>	$V_{DD}$ = - 10 V, $R_L$ = 2.5 $\Omega$ $I_D \cong$ - 4 A, $V_{GEN}$ = - 10 V, $R_g$ = 1 $\Omega$		5	10	
Rise Time	t <sub>r</sub>			15	25	
Turn-Off Delay Time	t <sub>d(off)</sub>			25	40	
Fall Time	t <sub>f</sub>			10	20	
<b>Drain-Source Body Diode Characteristic</b>	cs				L	
Continuous Source-Drain Diode Current	I <sub>S</sub>	T <sub>C</sub> = 25 °C	T <sub>C</sub> = 25 °C		- 6	Α
Pulse Diode Forward Current	I <sub>SM</sub>				- 20	
Body Diode Voltage	$V_{SD}$	I <sub>S</sub> = - 4 A, V <sub>GS</sub> = 0 V		- 0.9	- 1.2	٧
Body Diode Reverse Recovery Time	t <sub>rr</sub>	$I_F = -4$ A, $dI/dt = 100$ A/ $\mu$ s, $T_J = 25$ °C		25	50	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			10	20	nC
Reverse Recovery Fall Time	t <sub>a</sub>			9		ns
Reverse Recovery Rise Time	t <sub>b</sub>			16		

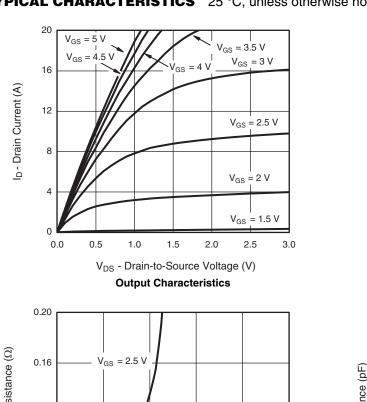
#### Notes:

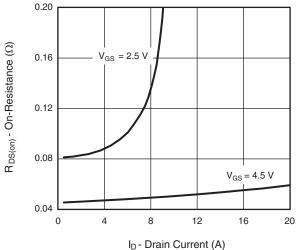
- a. Pulse test; pulse width  $\leq 300~\mu s,$  duty cycle  $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

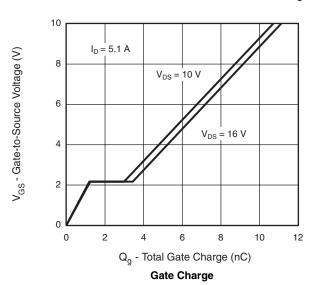


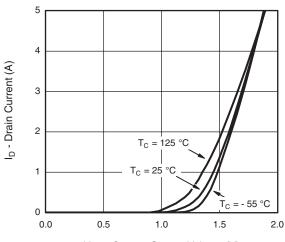
### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



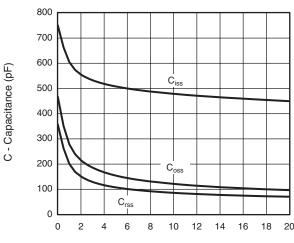


#### On-Resistance vs. Drain Current and Gate Voltage

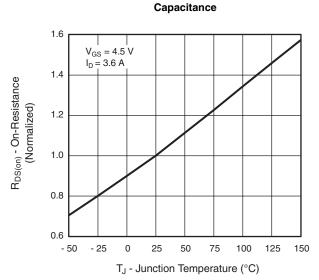




V<sub>GS</sub> - Gate-to-Source Voltage (V) **Transfer Characteristics** 



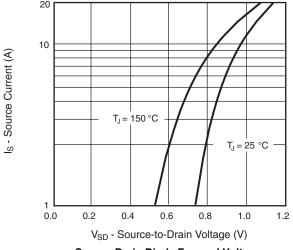
V<sub>DS</sub> - Drain-to-Source Voltage (V)



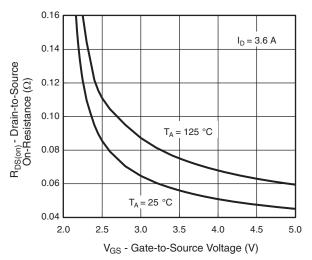
On-Resistance vs. Junction Temperature

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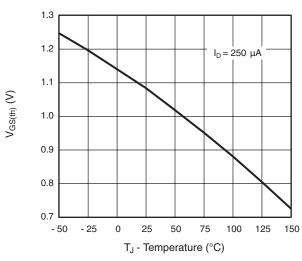
## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



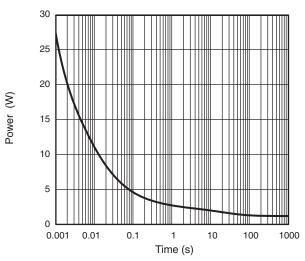




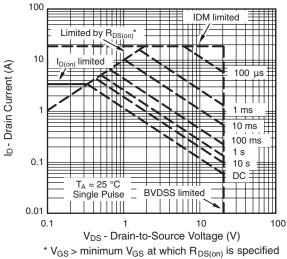
On-Resistance vs. Gate-to-Source Voltage



**Threshold Voltage** 



Single Pulse Power, Junction-to-Ambient



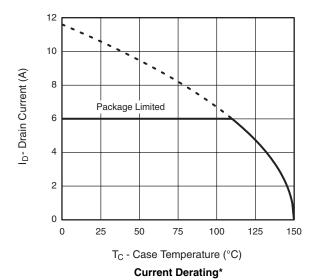
Safe Operating Area, Junction-to-Case

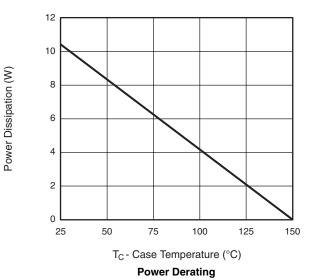






## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



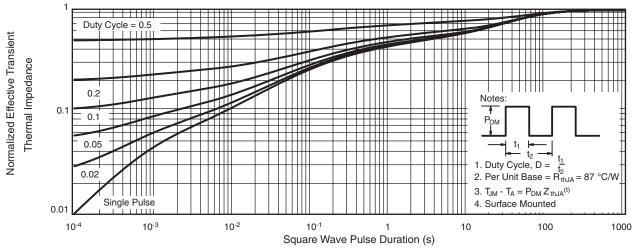


<sup>\*</sup> The power dissipation  $P_D$  is based on  $T_{J(max)}$  = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

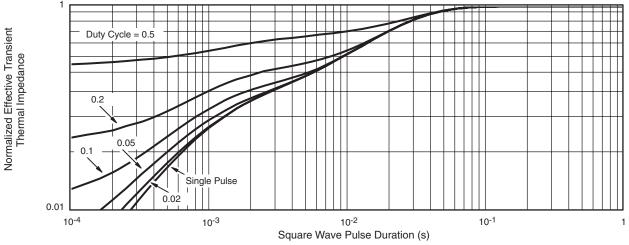
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#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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